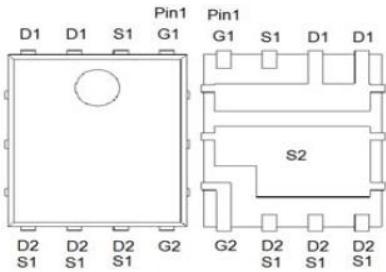


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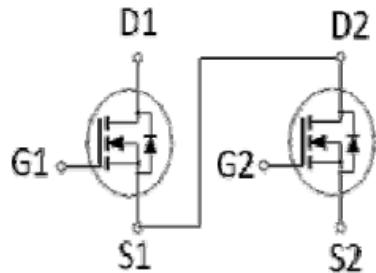
Dual N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D	CH.
30V	1.2mΩ @ $V_{GS} = 10V$	127A	Q2
30V	6.5mΩ @ $V_{GS} = 10V$	43A	Q1



PDFN 5*6P



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	CH.	LIMITS	UNITS	
Drain-Source Voltage	$T_C = 25^\circ C$	V_{DS}	Q2	30	V	
			Q1	30		
Gate-Source Voltage	$T_C = 25^\circ C$	V_{GS}	Q2	± 20		
			Q1	± 20		
Continuous Drain Current ³	$T_C = 25^\circ C$	I_D	Q2	127	A	
			Q1	43		
	$T_C = 100^\circ C$		Q2	80		
			Q1	27		
Pulsed Drain Current ¹	$T_C = 25^\circ C$	I_{DM}	Q2	160		
			Q1	100		
Continuous Drain Current	$T_A = 25^\circ C$	I_D	Q2	32		
			Q1	11		
	$T_A = 70^\circ C$		Q2	25		
			Q1	9.4		
Avalanche Current	$T_A = 25^\circ C$	I_{AS}	Q2	68.6	mJ	
			Q1	25		
Avalanche Energy	$L = 0.1mH$	E_{AS}	Q2	235		
			Q1	31		
Power Dissipation	$T_C = 25^\circ C$	P_D	Q2	39	W	
			Q1	24		
	$T_C = 100^\circ C$		Q2	15		
			Q1	9.8		

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Dual N-Channel Enhancement Mode MOSFET

Power Dissipation	T _A = 25 °C	P _D	Q2	2.5	W
	T _A = 70 °C		Q1	1.7	
Operating Junction & Storage Temperature Range	T _J , T _{STG}		Q2	1.6	
			Q1	1.1	
Operating Junction & Storage Temperature Range		T _J , T _{STG}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	CH.	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	R _{θJA}	Q2		50	°C / W
		Q1		70	
Junction-to-Case	R _{θJC}	Q2		3.2	°C / W
		Q1		5.1	

¹Pulse width limited by maximum junction temperature T_{J(MAX)}=150°C.

²The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design.

³Package limitation current :Q1=35A,Q2=35A.

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	CH.	LIMITS			UNITS
				MIN	TYP	MAX	
STATIC							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	Q2	30			V
			Q1	30			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	Q2	1.3	1.8	2.3	
			Q1	1.3	1.6	2.3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	Q2			±100	nA
			Q1			±100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V	Q2			1	μA
			Q1			1	
		V _{DS} = 20V, V _{GS} = 0V , T _J = 55 °C	Q2			10	
			Q1			10	
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 16A	Q2		1.2	1.6	mΩ
		V _{GS} = 4.5V, I _D = 11A	Q1		6	9.5	
		V _{GS} = 10V, I _D = 20A	Q2		0.85	1.2	
		V _{GS} = 10V, I _D = 11A	Q1		4.3	6.5	
Forward Transconductance ¹	g _f	V _{DS} = 5V, I _D = 20A	Q2		68		S
		V _{DS} = 5V, I _D = 11A	Q1		50		

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Dual N-Channel Enhancement Mode MOSFET

DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$	Q2		4056	
Output Capacitance	C_{oss}		Q1		888	
Reverse Transfer Capacitance	C_{rss}		Q2		782	
Gate Resistance	R_g		Q1		171	
Total Gate Charge ²	Q_g		Q2		456	
Gate-Source Charge ²	Q_{gs}		Q1		99	
Gate-Drain Charge ²	Q_{gd}	$V_{DS} = 15V, V_{GS} = 10V, I_D = 20A$ $V_{DS} = 15V, V_{GS} = 10V, I_D = 11A$	Q2		1	
Turn-On Delay Time ²	$t_{d(on)}$		Q1		1.1	
Rise Time ²	t_r		Q2		81	
Turn-Off Delay Time ²	$t_{d(off)}$		Q1		17.3	
Fall Time ²	t_f		Q2		43	
			Q1		9.3	
			Q2		12	
			Q1		2.5	
			Q2		19	
			Q1		4.7	
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)						
Continuous Current ³	I_S	$I_F = 20A, V_{GS} = 0V$ $I_F = 11A, V_{GS} = 0V$	Q2		39	
Forward Voltage ¹	V_{SD}		Q1		20	A
Reverse Recovery Time	t_{rr}	$I_F = 20A, dI_F/dt = 100A/\mu s$ $I_F = 11A, dI_F/dt = 100A/\mu s$	Q2		1	
Reverse Recovery Charge	Q_{rr}		Q1		1.2	V
			Q2		28	
			Q1		8.2	nS
			Q2		15	
			Q1		1.3	nC

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

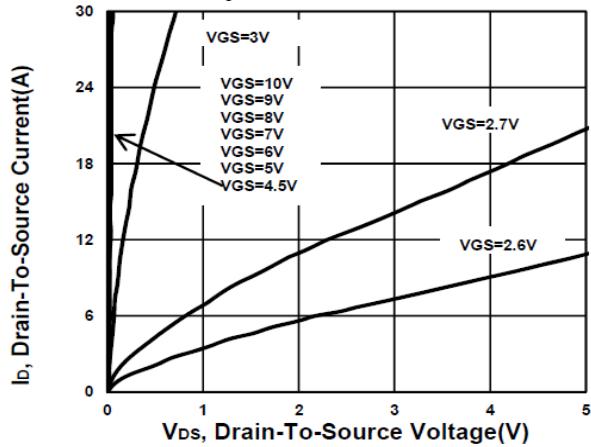
³Package limitation current : Q1=35A, Q2=35A.

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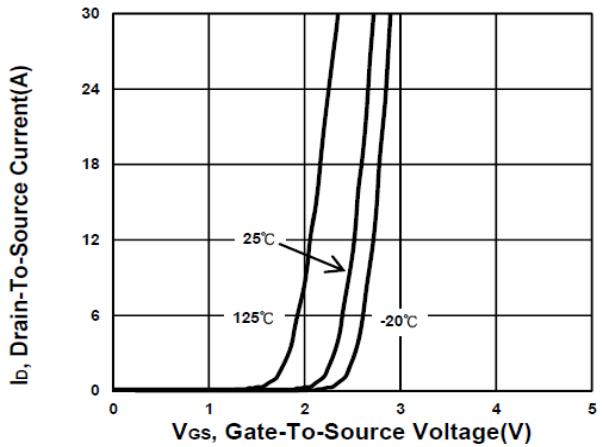
Dual N-Channel Enhancement Mode MOSFET

Q2

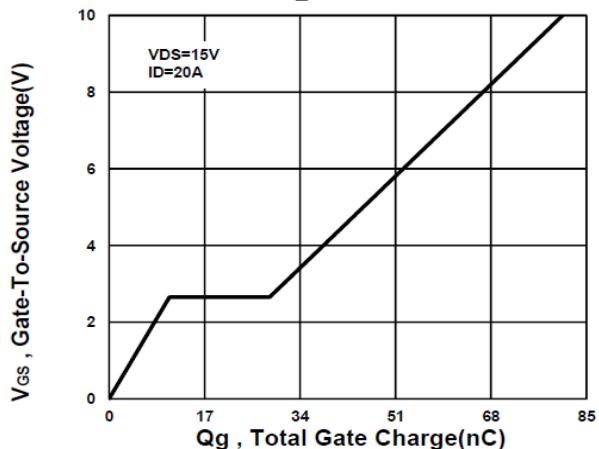
Output Characteristics



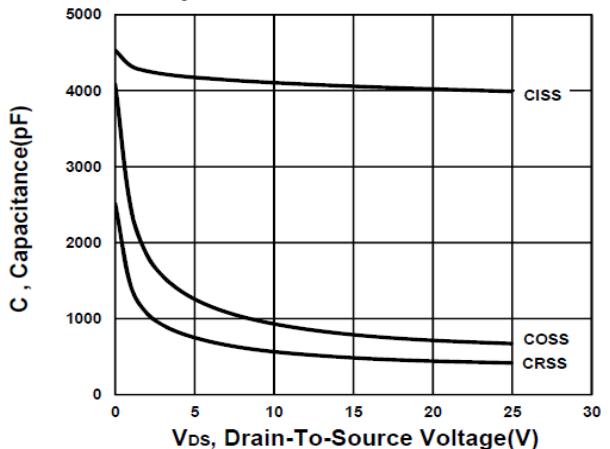
Transfer Characteristics



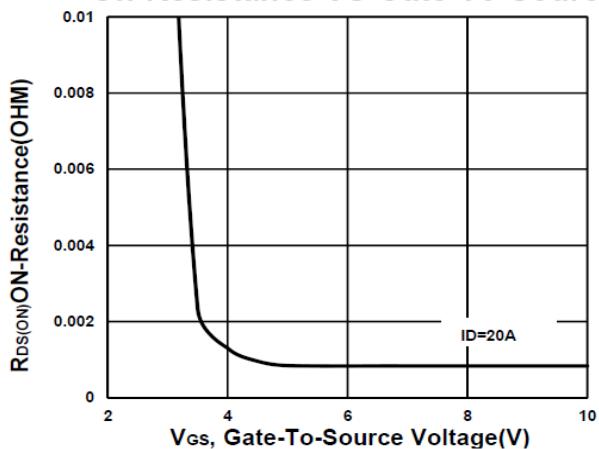
Gate charge Characteristics



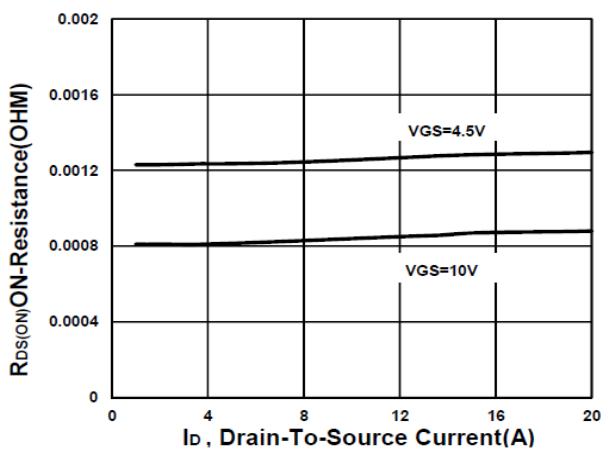
Capacitance Characteristic



On-Resistance VS Gate-To-Source

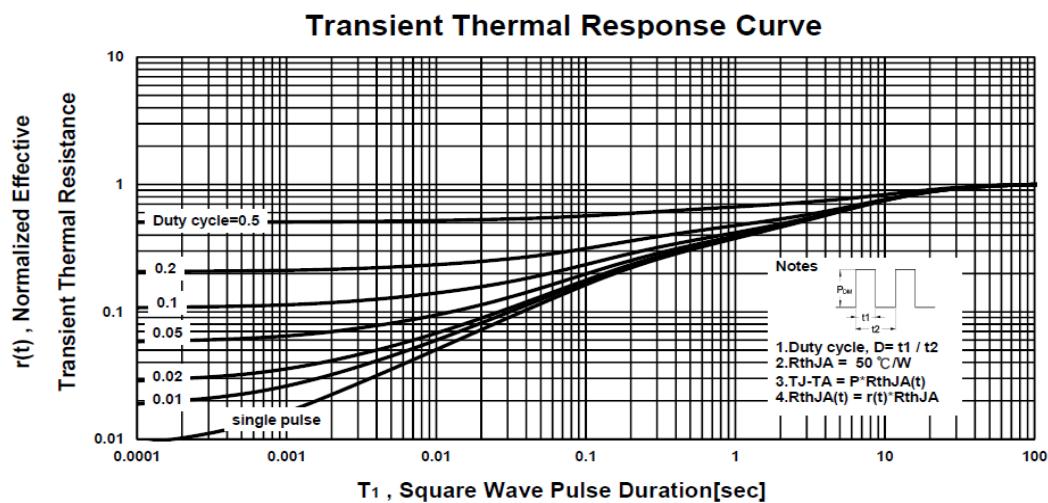
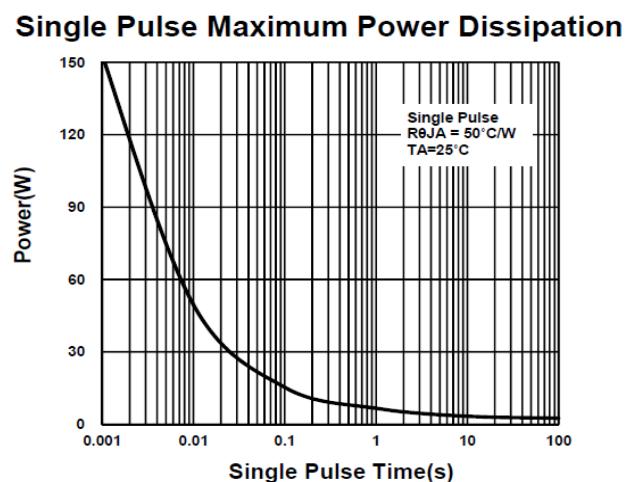
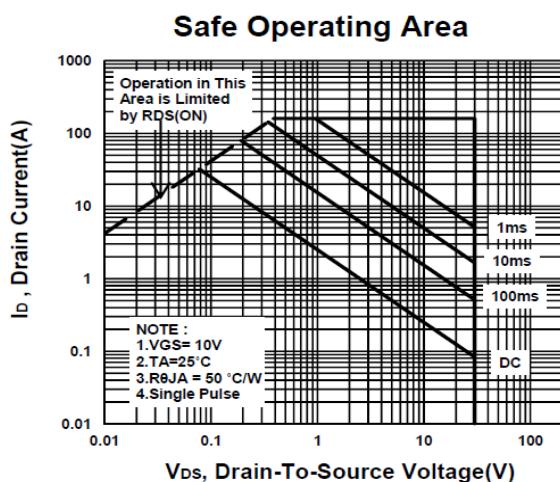
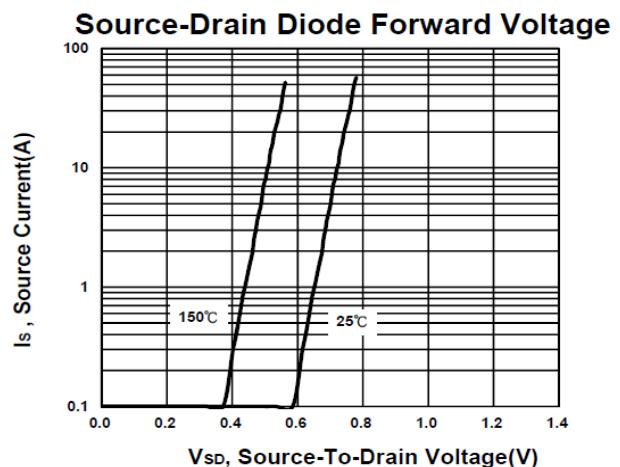
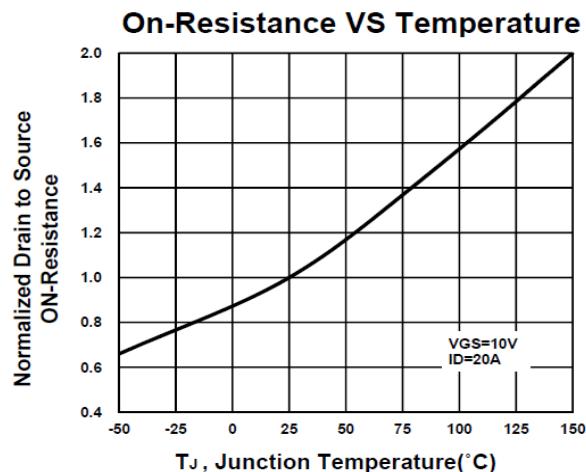


On-Resistance VS Drain Current



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Dual N-Channel Enhancement Mode MOSFET

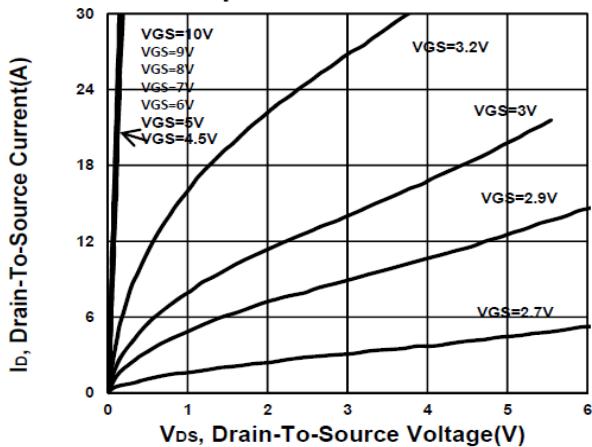


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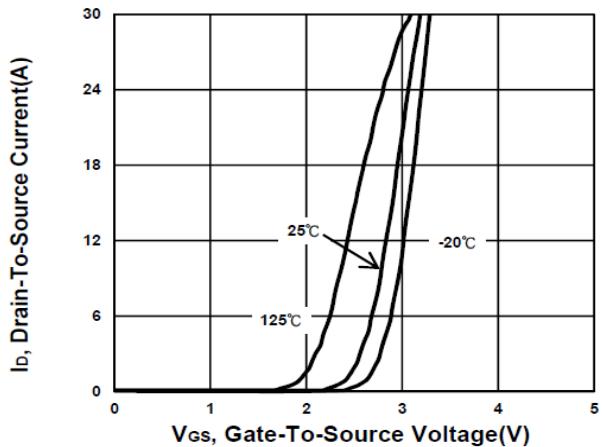
Dual N-Channel Enhancement Mode MOSFET

Q1

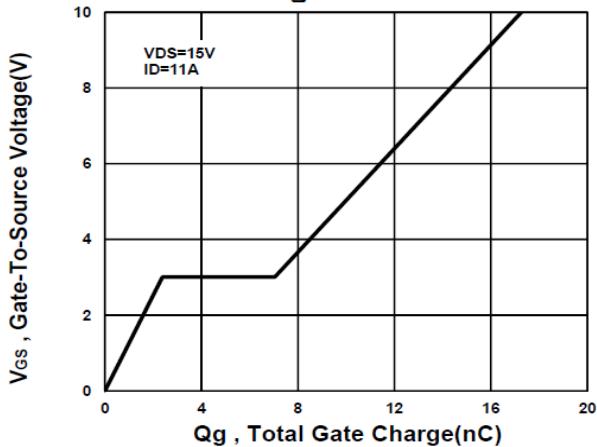
Output Characteristics



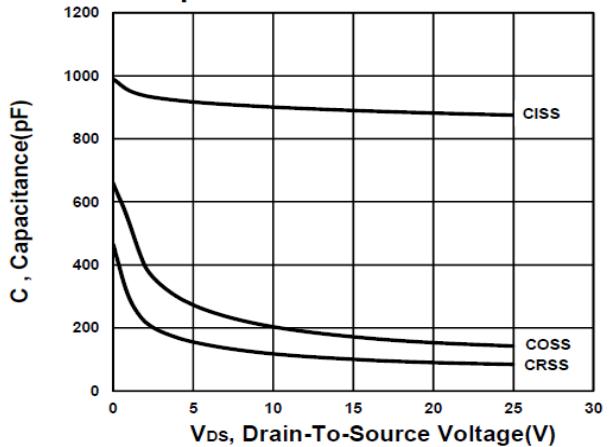
Transfer Characteristics



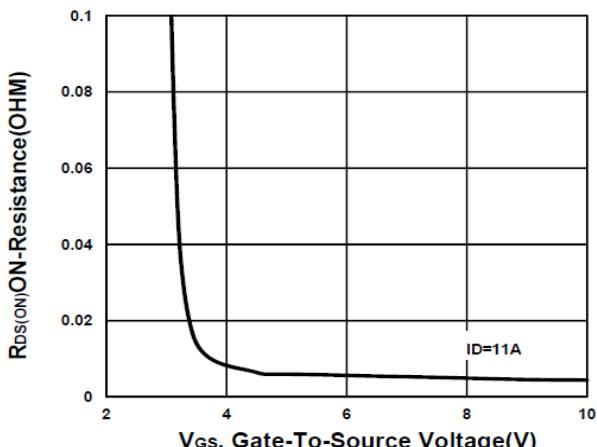
Gate charge Characteristics



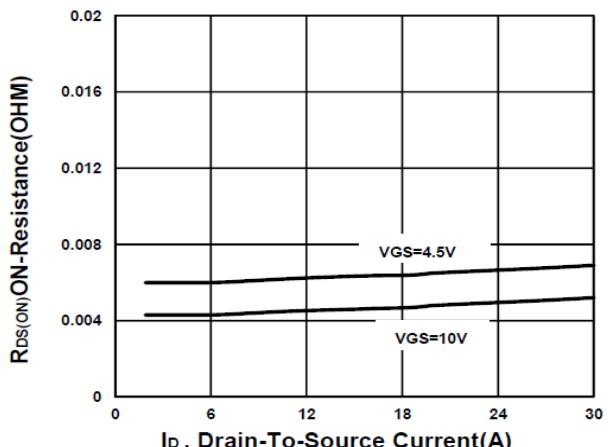
Capacitance Characteristic



On-Resistance VS Gate-To-Source

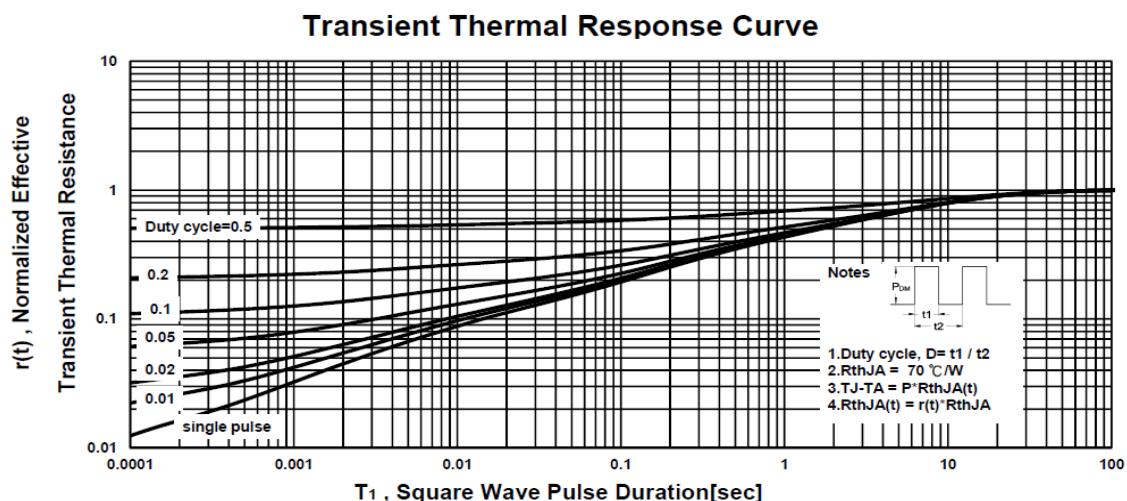
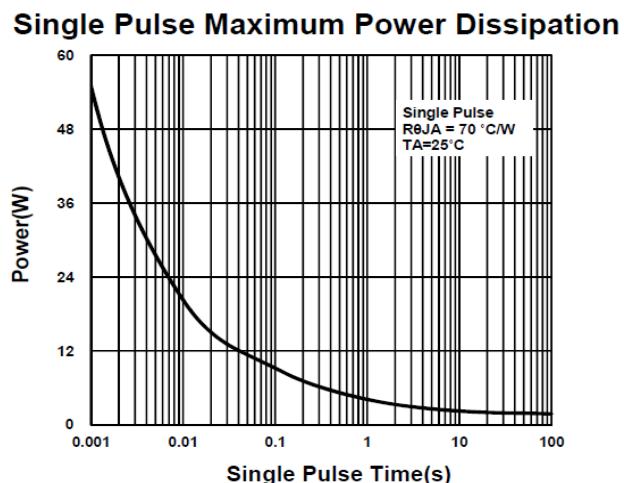
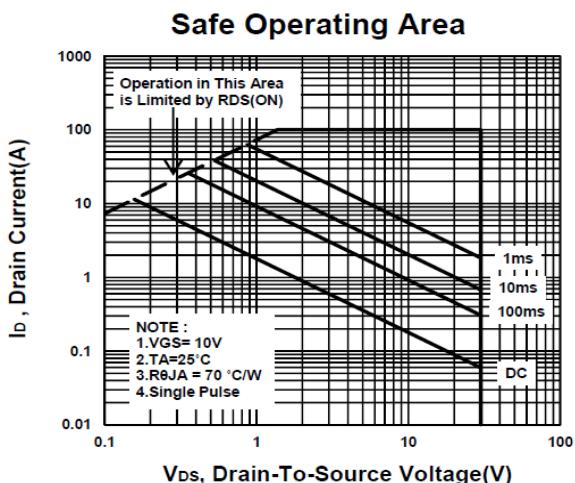
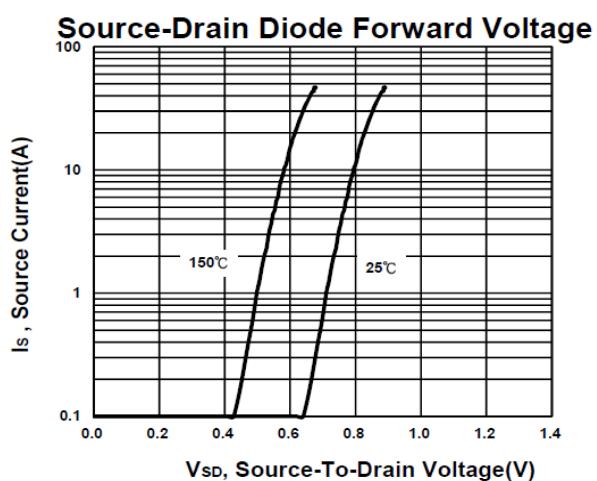
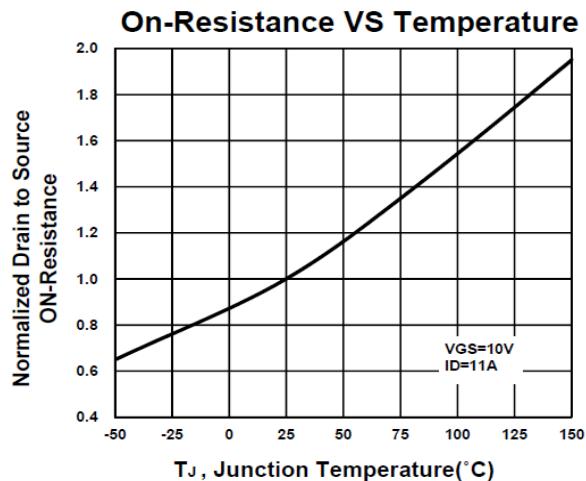


On-Resistance VS Drain Current



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Dual N-Channel Enhancement Mode MOSFET



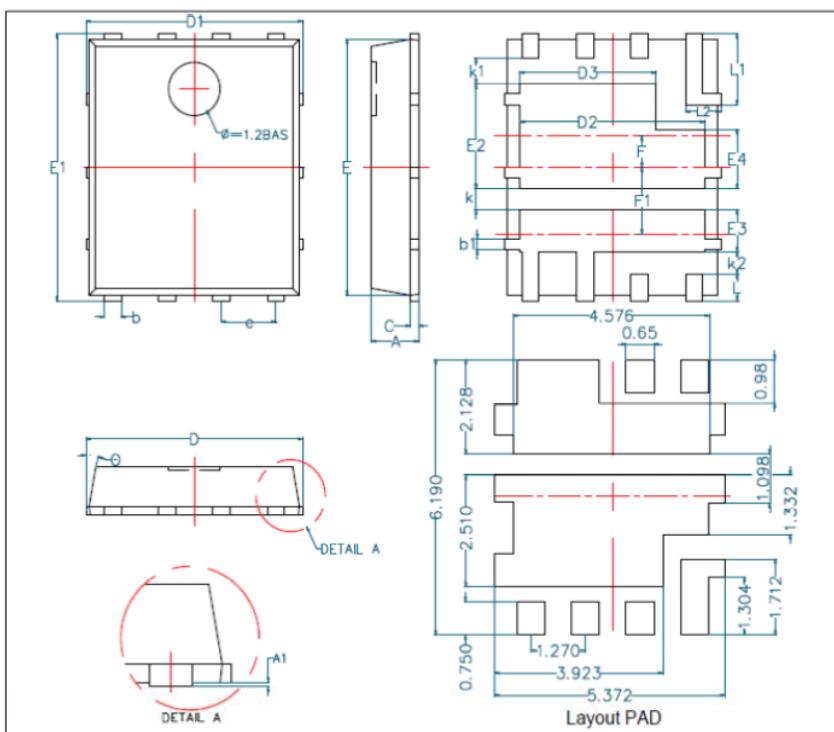
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Dual N-Channel Enhancement Mode MOSFET

Package Dimension

PDFN 5x6P(Dual flip chip) MECHANICAL DATA

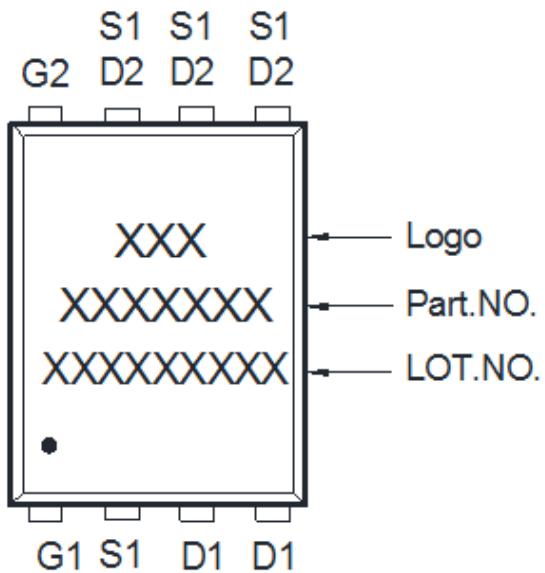
Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	1.00		1.20	E3	0.85		1.15
A1	0.00		0.05	E4	1.23		1.53
b	0.30		0.50	e	1.27 BSC		
b1	0.15		0.35	Θ	10° REF		
c	0.15		0.25	L	0.40		0.60
D1	5.05 BSC			L1	1.50		1.70
D	4.80		5.00	L2	0.72		0.92
D2	4.15		4.45	K	0.47 BSC		
D3	3.02		3.32	K1	0.58 BSC		
E1	6.00 BSC			K2	0.50 BSC		
E	5.65		5.85	F	0.695 REF		
E2	2.30		2.60	F1	1.50REF		



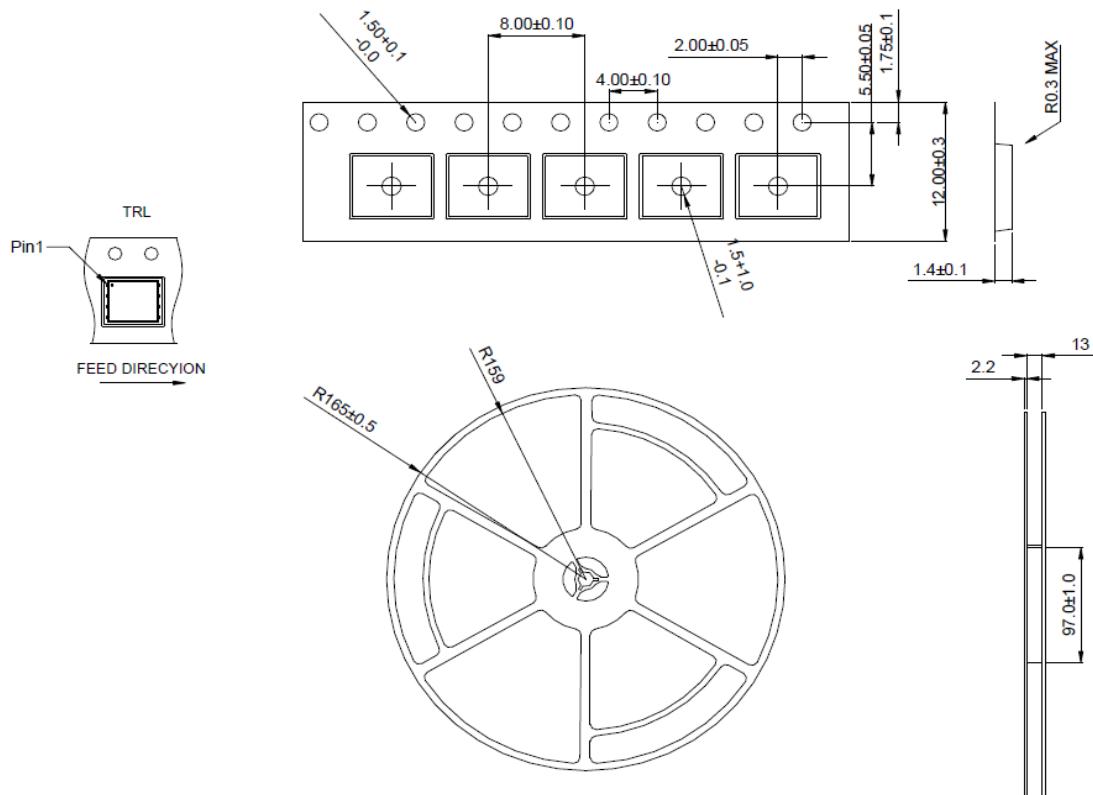
PK610DZ

Dual N-Channel Enhancement Mode MOSFET

A. Marking Information



B. Tape&Reel Information: 3000pcs/Reel

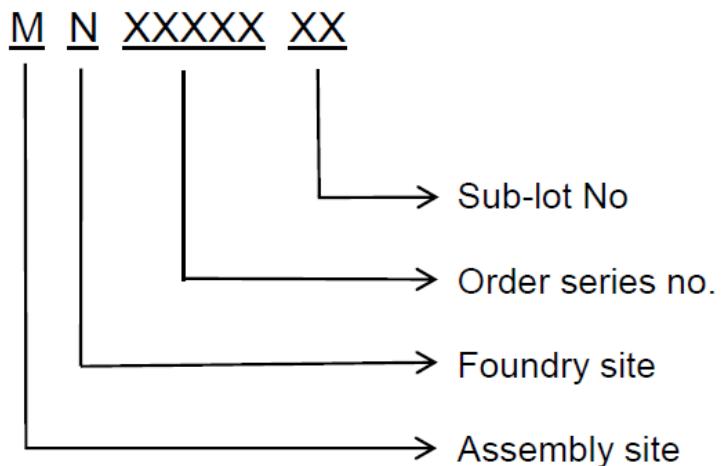


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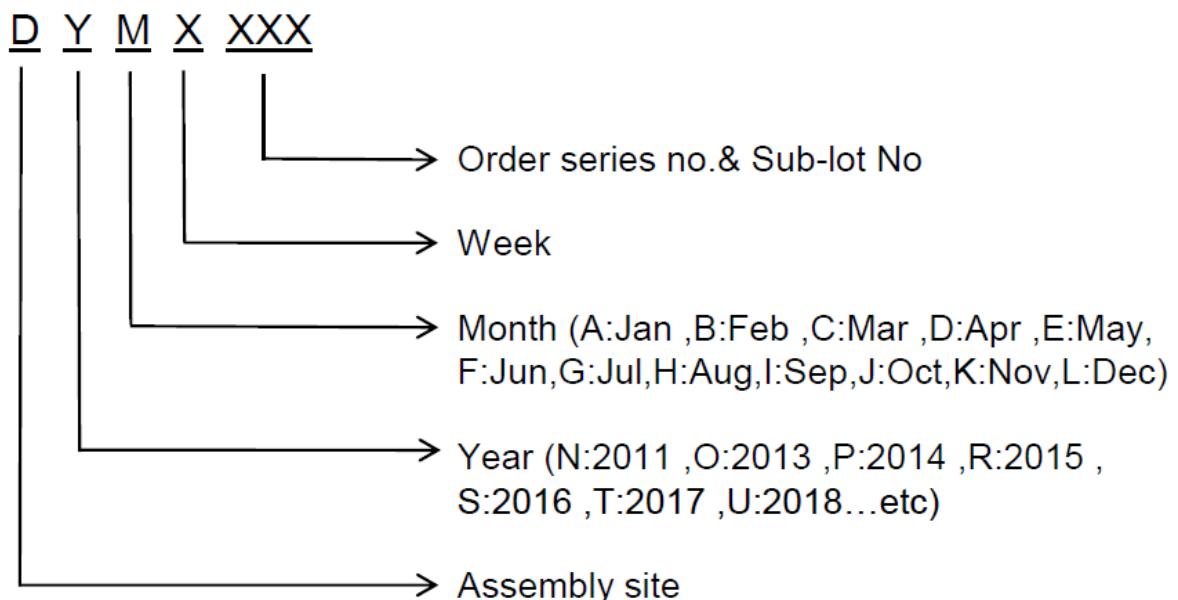
Dual N-Channel Enhancement Mode MOSFET

C. Lot No.&Date Code rule

1. Lot No.



2. Date Code





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Dual N-Channel Enhancement Mode MOSFET

D.Label rule

标签内容(Label content)



1	Label Size	30 * 90 mm		
2	Font style	Times New Roman or Arial (或可区分英文“0”和数字“0”，“G”和“Q”的字型即可)		
3	U-NIKC	Height: 4 mm		
4	Package	Height: 2 mm		
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12		
6	Device	Height: 3 mm (Max: 16 Digit)		
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot		
8	D/C	Height: 3 mm (Max: 7 Digit)		
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed		
10	RoHS label	 long axis: 12 mm minor axis: 6 mm bottom color: White Font color: Black Font style: Arial		
11	Halogen Free label	 Diameter: 10 mm bottom color: Green Font color: Black Font style: Arial		
12	Scan information	Device / Lot / D/C / QTY , Insert “ / ” between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least		